TOSHIBA Field Effect Transistor Silicon N Channel MOS Type (π–MOSV)

2SK2952

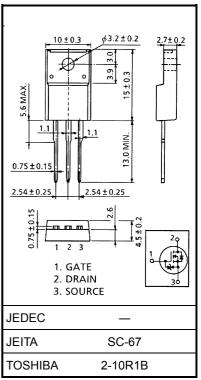
Chopper Regulator Applications

Unit: mm

 $\begin{array}{ll} \bullet & Low\ drain-source\ ON\ resistance & \vdots\ R_{DS}\ (o_N)=0.4\ \Omega\ (typ.) \\ \bullet & High\ forward\ transfer\ admittance & \vdots\ |Y_{fs}|=8.0\ S\ (typ.) \\ \bullet & Low\ leakage\ current & \vdots\ I_{DSS}=100\ \mu A\ (max)\ (V_{DS}=400\ V) \\ \bullet & Enhancement-mode & \vdots\ V_{th}=2.0{\sim}4.0\ V\ (V_{DS}=10\ V,\ I_D=1\ mA) \end{array}$

Maximum Ratings (Ta = 25°C)

Characteristics		Symbol	Rating	Unit	
Drain-source voltage		V_{DSS}	400	V	
Drain-gate voltage (R _{GS} = 20 kΩ)		V_{DGR}	400	V	
Gate-source voltage		V _{GSS}	±30	V	
Drain current	DC (Note 1)	I _D	8.5	Α	
	Pulse (Note 1)	I _{DP}	34	Α	
Drain power dissipation	n (Tc = 25°C)	P_{D}	40	W	
Single pulse avalanche energy (Note 2)		E _{AS}	427	mJ	
Avalanche current		I _{AR}	8.5	Α	
Repetitive avalanche e	nergy (Note 3)	E _{AR}	4.0	mJ	
Channel temperature		T _{ch}	150	°C	
Storage temperature range		T _{stg}	-55~150	°C	



Weight: 1.9 g (typ.)

Thermal Characteristics

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to case	R _{th (ch-c)}	3.125	°C/W
Thermal resistance, channel to ambient	R _{th (ch-a)}	62.5	°C/W

Note 1: Please use devices on condition that the channel temperature is below 150°C.

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Note 2: V_{DD} = 90 V, T_{ch} = 25°C, L = 9.6 mH, R_G = 25 Ω , I_{AR} = 8.5 A

Note 3: Repetitive rating: Pulse width limited by maximum channel temperature

This transistor is an electrostatic sensitive device.

Please handle with caution.



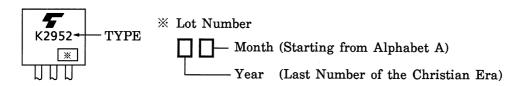
Electrical Characteristics (Ta = 25°C)

Charac	teristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	rrent	I _{GSS}	V _{GS} = ±25 V, V _{DS} = 0 V	_	_	±10	μΑ
Gate-source bre	eakdown voltage	V _(BR) GSS	$I_G = \pm 10 \mu\text{A}, V_{DS} = 0 \text{V}$	±30	_	-	V
Drain cut-off cui	rent	I _{DSS}	V _{DS} = 400 V, V _{GS} = 0 V	-	_	100	μA
Drain-source br	eakdown voltage	V _{(BR) DSS}	I _D = 10 mA, V _{GS} = 0 V	400	_	_	٧
Gate threshold v	roltage	V_{th}	V _{DS} = 10 V, I _D = 1 mA	2.0	_	4.0	٧
Drain-source Ol	N resistance	R _{DS} (ON)	V _{GS} = 10 V, I _D = 5 A	_	0.4	0.55	Ω
Forward transfer	admittance	Y _{fs}	V _{DS} = 10 V, I _D = 5 A	4.0	8.0	_	S
Input capacitano	е	C _{iss}			1340	_	pF
Reverse transfer	capacitance	C _{rss} V _{DS} = 10 V, V _{GS} = 0 V, f = 1 MHz		_	160	_	
Output capacitance		Coss]		490	_	
Switching time	Rise time	t _r	$V_{GS} \stackrel{10 \text{ V}}{_{0 \text{ V}}} \stackrel{I_{D} = 5 \text{ A}}{\underset{\text{RL} =}{\overset{\text{O}}{\underset{\text{VOUT}}{\text{NUT}}}}} V_{OUT}$	_	22	_	
	Turn-on time	t _{on}		_	60	_	20
	Fall time	t _f		_	32	_	ns
	Turn-off time	t _{off}	Duty $\leq 1\%$, $t_{\rm W} = 10 \mu{\rm s}$	_	140	_	
Total gate charge (gate-source plus gate-drain)		Qg			34		
Gate-source charge		Q _{gs}	$V_{DD} \approx 320 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8.5 \text{ A}$		18	_	nC
Gate-drain ("miller") Charge		Q_{gd}		_	16	_	

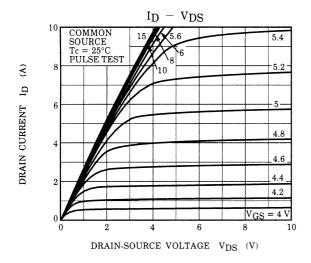
Source-Drain Ratings and Characteristics (Ta = 25°C)

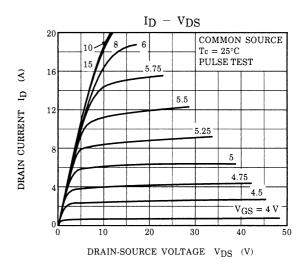
Characteristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	I _{DR}	_	_	_	8.5	А
Pulse drain reverse current (Note 1)	I _{DRP}	_	_		34	Α
Forward voltage (diode)	V _{DSF}	I _{DR} = 8.5 A, V _{GS} = 0 V	1	_	-1.7	V
Reverse recovery time		I _{DR} = 8.5 A, V _{GS} = 0 V	1	350	_	ns
Reverse recovery charge	Q_{rr}	dI _{DR} /dt = 100 A/μs	1	2.6	_	μC

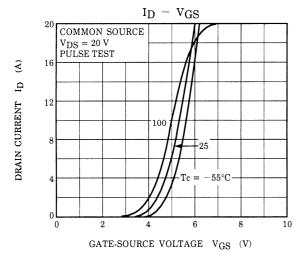
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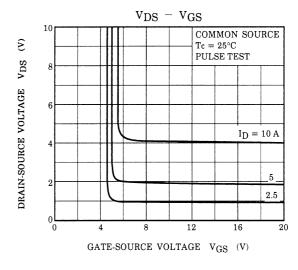


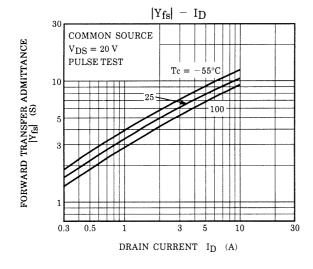
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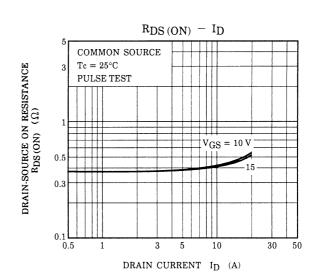




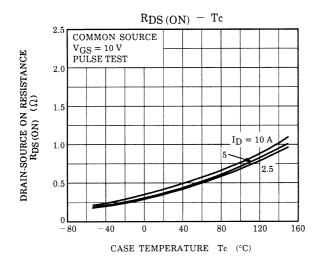


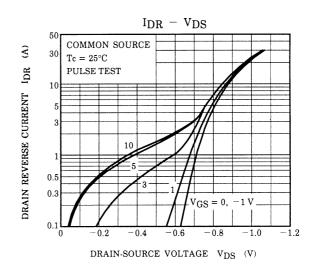


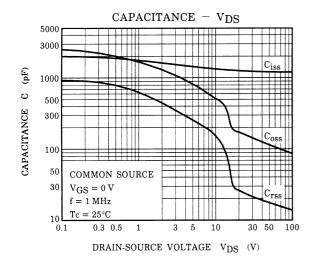


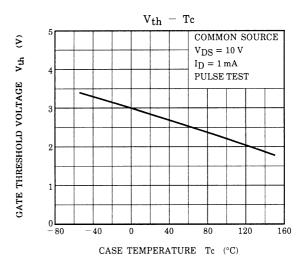


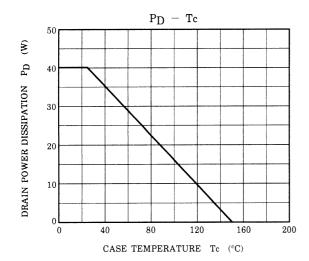
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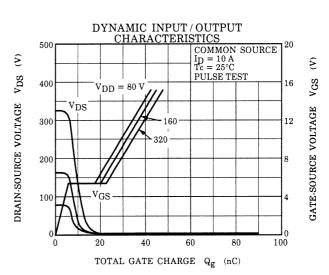




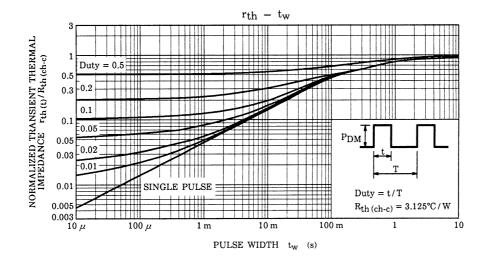


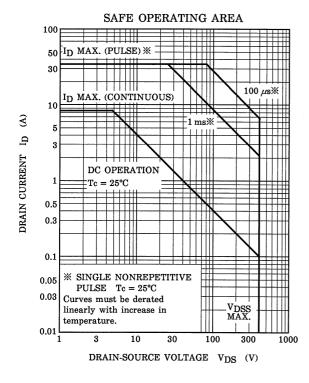


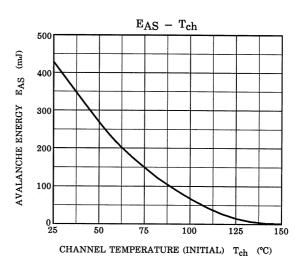


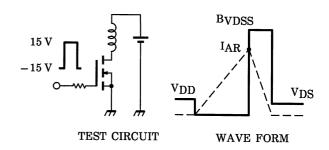


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$$\begin{aligned} &R_G = 25~\Omega \\ &V_{DD} = 90~V,~L = 9.6~mH \end{aligned} \qquad E_{AS} = \frac{1}{2} \cdot L \cdot I^2 \cdot \left(\frac{B_{VDSS}}{B_{VDSS} - V_{DD}} \right) \end{aligned}$$

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